

Title (en)  
METHOD FOR PRODUCING PLATED ARTICLE

Title (de)  
VERFAHREN ZUR HERSTELLUNG EINES PLATTIERTEN ARTIKELS

Title (fr)  
PROCÉDÉ POUR LA PRODUCTION D'UN ARTICLE PLAQUÉ

Publication  
**EP 3276042 A1 20180131 (EN)**

Application  
**EP 16768841 A 20160323**

Priority  
• JP 2015061779 A 20150324  
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Abstract (en)  
There is provided a method for producing a plated article in which a plating film pattern is formed on the surface of a glass substrate, comprising a first step of irradiating a partial area of the surface of the glass substrate with a pulsed laser; a second step of attaching an electroless catalyst on the surface of the glass substrate; a third step of selectively deactivating or selectively removing the catalyst attached to the unirradiated area with the pulsed laser in the glass substrate; and a fourth step of nonelectrolytically plating the glass substrate after the third step to selectively form a plating film in the irradiated area with the pulsed laser. The method allows for easily producing a plated article in which a highly adherent plating film pattern is formed on the surface of the glass substrate.

IPC 8 full level  
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**US 201615314761 A 20160323**; CN 201680001511 A 20160323; EP 16768841 A 20160323; JP 2016059264 W 20160323; JP 2017508399 A 20160323